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# MOSFET – Power, Single, N-Channel

# 60 V, 4.0 mΩ, 100 A

# NTMFS5C645NL

#### **Features**

- Small Footprint (5x6 mm) for Compact Design
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- These Devices are Pb-Free and are RoHS Compliant

# **MAXIMUM RATINGS** (T<sub>J</sub> = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V <sub>DSS</sub>	60	V
Gate-to-Source Voltage	€		V <sub>GS</sub>	±20	V
Continuous Drain	Steady	T <sub>C</sub> = 25°C	I <sub>D</sub>	100	Α
Current R <sub>0JC</sub> (Notes 1, 3)		T <sub>C</sub> = 100°C		71	
Power Dissipation	State	T <sub>C</sub> = 25°C	$P_{D}$	79	W
R <sub>θJC</sub> (Note 1)		T <sub>C</sub> = 100°C		40	
Continuous Drain	Steady State	T <sub>A</sub> = 25°C	I <sub>D</sub>	22	Α
Current R <sub>θJA</sub> (Notes 1, 2, 3)		T <sub>A</sub> = 100°C		15	
Power Dissipation		T <sub>A</sub> = 25°C	$P_{D}$	3.7	W
R <sub>θJA</sub> (Notes 1 & 2)		T <sub>A</sub> = 100°C	1	1.8	
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \mu s$		I <sub>DM</sub>	820	Α
Operating Junction and Storage Temperature			T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C
Source Current (Body Diode)			IS	100	Α
Single Pulse Drain-to-Source Avalanche Energy (I <sub>L(pk)</sub> = 5 A)			E <sub>AS</sub>	185	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			TL	260	°C

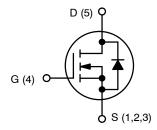
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

# THERMAL RESISTANCE MAXIMUM RATINGS

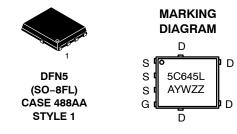
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	1.9	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	41	

- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.
- 3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
60 V	4.0 mΩ @ 10 V	100 A
	5.7 m $\Omega$ @ 4.5 V	100 A



**N-CHANNEL MOSFET** 



5C645L = Specific Device Code A = Assembly Location

Y = Year
W = Work Week
ZZ = Lot Traceability

## **ORDERING INFORMATION**

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

NOTE: Some of the device on this data sheet have been **DISCONTINUED**. Please refer to the table on page 5.

# **ELECTRICAL CHARACTERISTICS** ( $T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> /				15.5		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V,	T <sub>J</sub> = 25 °C			10	
		V <sub>DS</sub> = 48 V	T <sub>J</sub> = 125°C			250	μΑ
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = 20 V				100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>E</sub>	) = 80 μΑ	1.2		2.0	V
Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				-4.9		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 50 A		3.3	4.0	
		V <sub>GS</sub> = 4.5 V	I <sub>D</sub> = 50 A		4.6	5.7	mΩ
Forward Transconductance	9 <sub>F</sub> s	V <sub>DS</sub> = 15 V, I	<sub>D</sub> = 50 A		105		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE				•	•	•
Input Capacitance	C <sub>ISS</sub>				2200		
Output Capacitance	Coss	V <sub>GS</sub> = 0 V, f = 1 MHz, V <sub>DS</sub> = 50 V			900		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>				17		
Total Gate Charge	Q <sub>G(TOT)</sub>	V <sub>GS</sub> = 4.5 V, V <sub>DS</sub> = 30 V; I <sub>D</sub> = 50 A			16		
Total Gate Charge	Q <sub>G(TOT)</sub>	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 30 V; I <sub>D</sub> = 50 A			34		1
Threshold Gate Charge	Q <sub>G(TH)</sub>	V <sub>GS</sub> = 4.5 V, V <sub>DS</sub> = 30 V; I <sub>D</sub> = 50 A			1.5		nC
Gate-to-Source Charge	Q <sub>GS</sub>				5.6		
Gate-to-Drain Charge	Q <sub>GD</sub>				5.1		
Plateau Voltage	$V_{GP}$				2.8		V
SWITCHING CHARACTERISTICS (Note:	5)						
Turn-On Delay Time	t <sub>d(ON)</sub>				10		
Rise Time	t <sub>r</sub>	V <sub>GS</sub> = 4.5 V, V	<sub>DS</sub> = 30 V,		15		1 _ '
Turn-Off Delay Time	t <sub>d(OFF)</sub>	$V_{GS} = 4.5 \text{ V}, V_{DS} = 30 \text{ V},$ $I_{D} = 50 \text{ A}, R_{G} = 2.5 \Omega$			24		ns -
Fall Time	t <sub>f</sub>				5.0		
DRAIN-SOURCE DIODE CHARACTERIS	STICS						
Forward Diode Voltage	$V_{SD}$	V <sub>GS</sub> = 0 V,	T <sub>J</sub> = 25°C		0.88	1.2	.,
		I <sub>S</sub> = 50 A	$I_S = 50 \text{ A}$ $T_J = 125^{\circ}\text{C}$ 0.78		V		
Reverse Recovery Time	t <sub>RR</sub>	$V_{GS} = 0 \text{ V, } dI_{S}/dt = 100 \text{ A}/\mu\text{s,}$ $I_{S} = 50 \text{ A}$			41		
Charge Time	t <sub>a</sub>				21		ns
Discharge Time	t <sub>b</sub>				20		
Reverse Recovery Charge	Q <sub>RR</sub>				32		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.

5. Switching characteristics are independent of operating junction temperatures.

## **TYPICAL CHARACTERISTICS**

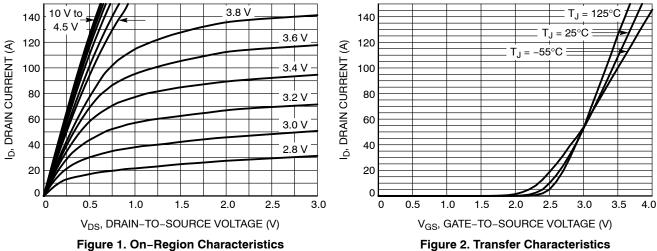


Figure 1. On-Region Characteristics

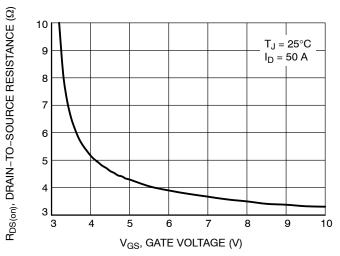


Figure 3. On-Resistance vs. Gate-to-Source Voltage

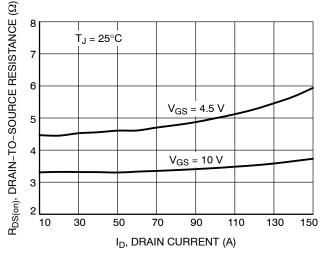


Figure 4. On-Resistance vs. Drain Current and **Gate Voltage** 

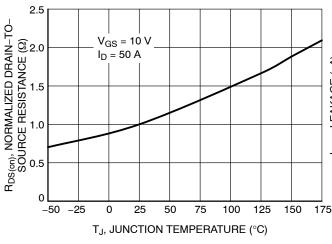


Figure 5. On-Resistance Variation with **Temperature** 

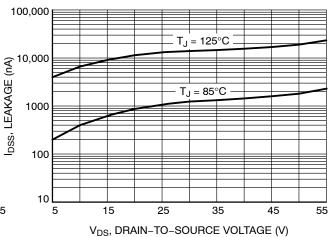
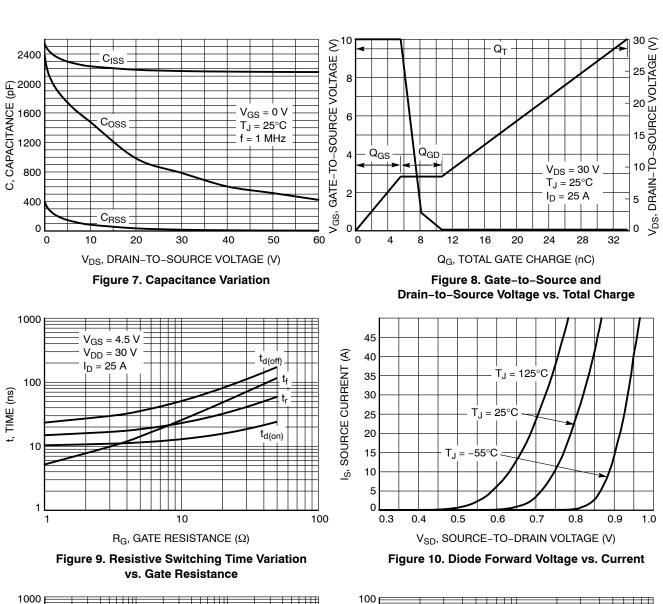


Figure 6. Drain-to-Source Leakage Current vs. Voltage

#### **TYPICAL CHARACTERISTICS**



100  $T_C = 25^{\circ}C$ 0.01 ms  $V_{GS}^{-} \le 10 \text{ V}$ 10  $T_{J(initial)} = 25^{\circ}C$ PEAK (A) 100° 10 ms R<sub>DS(on)</sub> Limit Thermal Limit Package Limit 0.1 1E-04 10 100 1E-03 1E-02 V<sub>DS</sub> (V) TIME IN AVALANCHE (s)

Figure 11. Safe Operating Area

100

10

l<sub>DS</sub> (A)

Figure 12. I<sub>PEAK</sub> vs. Time in Avalanche

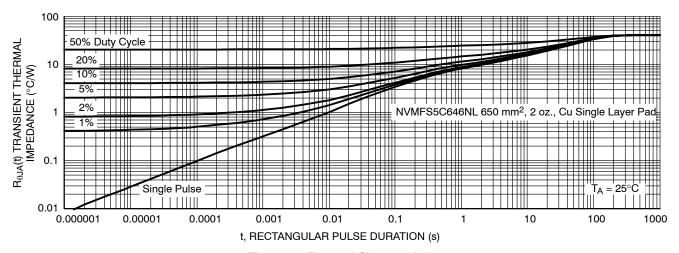


Figure 13. Thermal Characteristics

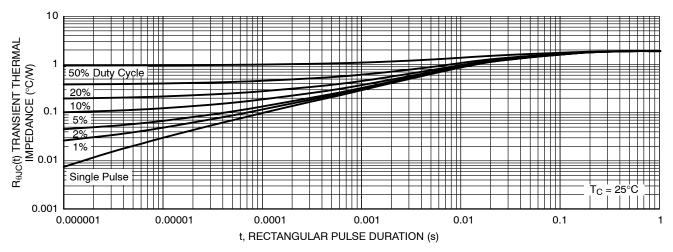


Figure 14. Thermal Response

## **ORDERING INFORMATION**

Device	Marking	Package	Shipping <sup>†</sup>			
NTMFS5C645NLT1G	5C645L	DFN5 (Pb-Free)	1500 / Tape & Reel			
DISCONTINUED (Note 6)						
NTMFS5C645NLT3G	5C645L	DFN5	1500 / Tape & Reel			

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

(Pb-Free)

<sup>6.</sup> **DISCONTINUED:** This device is not recommended for new design. Please contact your **onsemi** representative for information. The most current information on this device may be available on <a href="https://www.onsemi.com">www.onsemi.com</a>.





0.10

SIDE VIEW

DFN5 5x6, 1.27P (SO-8FL) CASE 488AA ISSUE N

**DATE 25 JUN 2018** 

#### NOTES:

- DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETER. DIMENSION D1 AND E1 DO NOT INCLUDE
- MOLD FLASH PROTRUSIONS OR GATE BURRS

	MILLIMETERS				
DIM	MIN	NOM	MAX		
Α	0.90	1.00	1.10		
A1	0.00		0.05		
b	0.33	0.41	0.51		
С	0.23	0.28	0.33		
D	5.00	5.15	5.30		
D1	4.70	4.90	5.10		
D2	3.80	4.00	4.20		
E	6.00	6.15	6.30		
E1	5.70	5.90	6.10		
E2	3.45	3.65	3.85		
е		1.27 BSC			
G	0.51	0.575	0.71		
K	1.20	1.35	1.50		
L	0.51	0.575	0.71		
L1	0.125 REF				
M	3.00	3.40	3.80		
θ	0 °		12 °		

## **GENERIC MARKING DIAGRAM\***



XXXXXX = Specific Device Code

= Lot Traceability

= Assembly Location Α

Υ = Year W = Work Week

ZZ

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ", may or may not be present. Some products may not follow the Generic Marking.





**DETAIL** A

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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